### 2.5 V/3.3 V ECL DUAL Differential 2:1 Multiplexer

## NB100LVEP56

## Description

The NB100LVEP56 is a dual, fully differential 2:1 multiplexer. The differential data path makes the device ideal for multiplexing low skew clock or differential data signals. The device features both individual and common select inputs to address both data path and random logic applications. Common and individual selects can accept both LVECL and LVCMOS input voltage levels. Multiple $\mathrm{V}_{\mathrm{BB}}$ pins are provided.

The $\mathrm{V}_{\mathrm{BB}}$ pin, an internally generated voltage supply, is available to this device only. For single-ended input operation, the unused differential input is connected to $\mathrm{V}_{\mathrm{BB}}$ as a switching reference voltage. $\mathrm{V}_{\mathrm{BB}}$ may also rebias AC coupled inputs. When used, decouple $\mathrm{V}_{\mathrm{BB}}$ and $\mathrm{V}_{\mathrm{CC}}$ via a $0.01 \mu \mathrm{~F}$ capacitor and limit current sourcing or sinking to 0.5 mA . When not used, $\mathrm{V}_{\mathrm{BB}}$ should be left open.

## Features

- Maximum Input Clock Frequency $>2.5 \mathrm{GHz}$ Typical
- Maximum Input Data Rate $>2.5 \mathrm{~Gb} / \mathrm{s}$ Typical
- 525 ps Typical Propagation Delays
- Low Profile QFN Package
- PECL Mode Operating Range:
$\mathrm{V}_{\mathrm{CC}}=2.375 \mathrm{~V}$ to 3.8 V with $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$
- NECL Mode Operating Range:
$\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ with $\mathrm{V}_{\mathrm{EE}}=-2.375 \mathrm{~V}$ to -3.8 V
- Separate, Common Select, and Individual Select
(Compatible with ECL and CMOS Input Voltage Levels)
- Q Output Will Default LOW with Inputs Open or at $\mathrm{V}_{\mathrm{EE}}$
- Multiple $\mathrm{V}_{\mathrm{BB}}$ Outputs
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant


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QFN24
MN SUFFIX CASE 485L

MARKING DIAGRAM*


| A | $=$ Assembly Location |
| :--- | :--- |
| L | $=$ Wafer Lot |
| Y | $=$ Year |
| W | $=$ Work Week |
| - | = Pb-Free Package |

(Note: Microdot may be in either location)
*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| NB100LVEP56MNG | QFN24 <br> (Pb-Free) | 92 Units / Tube |
| NB100LVEP56MNR2G | QFN24 <br> (Pb-Free) | $3000 /$ <br> Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Table 1. PIN FUNCTION DESCRIPTION

| Pin No. | Name | 1/0 | Default State | Description |
| :---: | :---: | :---: | :---: | :---: |
| QFN |  |  |  |  |
| $\begin{gathered} 3,9,18,19, \\ 20 \end{gathered}$ | $\mathrm{V}_{\mathrm{CC}}$ | - | - | Positive Supply Voltage. All VCC Pins must be Externally Connected to Power Supply to Guarantee Proper Operation. |
| 15,24 | $\mathrm{V}_{\mathrm{EE}}$ | - | - | Negative Supply Voltage. All VEE Pins must be Externally Connected to Power Supply to Guarantee Proper Operation. |
| 6,12 | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{BBO},} \\ & \mathrm{~V}_{\mathrm{BB} 1} \end{aligned}$ | - | - | ECL Reference Voltage Output |
| 4 | D0a | ECL Input | Low | Noninverted Differential Data a Input to MUX 0. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$. |
| 5 | D0a | ECL Input | High | Inverted Differential Data a Input to MUX 0. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$ and $37 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{Cc}}$. |
| 7 | DOb | ECL Input | Low | Noninverted Differential Data b Input to MUX 0 . Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$. |
| 8 | D0b | ECL Input | High | Inverted Differential Data b Input to MUX 0. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$ and $37 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{Cc}}$. |
| 10 | D1a | ECL Input | Low | Noninverted Differential Data a Input to MUX 1. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\text {EE }}$. |
| 11 | $\overline{\text { D1a }}$ | ECL Input | High | Inverted Differential Data a Input to MUX 1. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$ and $37 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{Cc}}$. |
| 13 | D1b | ECL Input | Low | Noninverted Differential Data b Input to MUX 1. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$. |
| 14 | $\overline{\text { D1b }}$ | ECL Input | High | Inverted Differential Data b Input to MUX 1. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$ and $37 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{Cc}}$. |
| 2 | Q0 | ECL Output | - | Noninverted Differential Output MUX 0 . Typically Terminated with $50 \Omega$ to $\mathrm{V}_{\mathrm{TT}}=$ $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$. |
| 1 | Q0 | ECL Output | - | Inverted Differential Output MUX 0. Typically Terminated with $50 \Omega$ to $\mathrm{V}_{\mathrm{TT}}=$ $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$. |
| 17 | Q1 | ECL Output | - | Noninverted Differential Output MUX 1. Typically Terminated with $50 \Omega$ to $\mathrm{V}_{\mathrm{TT}}=$ $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$. |
| 16 | Q1 | ECL Output | - | Inverted Differential Output MUX 1. Typically Terminated with $50 \Omega$ to $\mathrm{V}_{\mathrm{TT}}=$ $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$. |
| 23 | SELO | ECL, CMOS Input | Low | Noninverted Differential Select Input to MUX 0 . Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\text {EE }}$. |
| 22 | COM_SEL | ECL, CMOS Input | Low | Noninverted Differential Common Select Input to Both MUX. Internal $75 \mathrm{k} \Omega$ to $V_{E E}$. |
| 21 | SEL1 | ECL, CMOS Input | Low | Noninverted Differential Select Input to MUX 1. Internal $75 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{EE}}$. |
| - | EP | - |  | Exposed Pad. The exposed pad (EP) on the package bottom must be attached to a heat-sinking conduit. The exposed pad may only be electrically connected to $\mathrm{V}_{\mathrm{EE}}$. |

## NB100LVEP56



Figure 2. QFN-24 Lead Pinout (Top View)

Table 3. ATTRIBUTES

| Characteristics | Value |
| :--- | :---: |
| Internal Input Pulldown Resistor (R1) | $75 \mathrm{k} \Omega$ |
| Internal Input Pullup Resistor (R2) | $37 \mathrm{k} \Omega$ |
| $\begin{array}{l}\text { ESD Protection } \\ \text { Human Body Model } \\ \text { Machine Model } \\ \text { Charged Device Model }\end{array}$ | $\begin{array}{c}>2 \mathrm{kV} \\ >150 \mathrm{~V} \\ >2 \mathrm{kV}\end{array}$ |
| $\begin{array}{l}\text { Moisture Sensitivity (Note 1) } \\ \text { QFN-24 }\end{array}$ | $\begin{array}{c}\text { Pb-Free Pkg } \\ \text { Level 1 }\end{array}$ |
| $\begin{array}{l}\text { Flammability Rating } \\ \text { Oxygen Index: 28 to 34 }\end{array}$ | $\mathrm{UL} 94 \mathrm{~V}-0$ @ 0.125 in |$]$| 354 Devices |
| :--- |
| Transistor Count |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test |

1. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Positive Mode Power Supply | $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$ |  | 6 | V |
| $\mathrm{V}_{\mathrm{EE}}$ | Negative Mode Power Supply | $\mathrm{V}_{\text {CC }}=0 \mathrm{~V}$ |  | -6 | V |
| $\mathrm{V}_{1}$ | Positive Mode Input Voltage Negative Mode Input Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{CC}} \\ & \mathrm{~V}_{\mathrm{I}} \geq \mathrm{V}_{\mathrm{EE}} \end{aligned}$ | $\begin{gathered} \hline 6 \\ -6 \end{gathered}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| $\mathrm{I}_{\text {out }}$ | Output Current | Continuous Surge |  | $\begin{gathered} 50 \\ 100 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| $\mathrm{I}_{\text {BB }}$ | $\mathrm{V}_{\mathrm{BB}}$ Sink/Source |  |  | $\pm 0.5$ | mA |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range |  |  | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage Temperature Range |  |  | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}$ | Thermal Resistance (Junction-to-Ambient) JEDEC 51-6 (2S2P-Multi Layer Test Board) with Filled Thermal Vias | $\begin{aligned} & 0 \text { lfpm } \\ & 500 \mathrm{lfpm} \end{aligned}$ | $\begin{aligned} & \text { QFN-24 } \\ & \text { QFN-24 } \end{aligned}$ | $\begin{aligned} & \hline 37 \\ & 32 \end{aligned}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} / \mathrm{W} \\ & { }^{\circ} \mathrm{C} / \mathrm{W} \end{aligned}$ |
| $\theta_{\text {Jc }}$ | Thermal Resistance (Junction-to-Case) | Standard Board | QFN-24 | 11 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{T}_{\text {sol }}$ | Wave Solder (Pb-Free) |  |  | 265 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 5. DC CHARACTERISTICS, PECL $V_{C C}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}$ (Note 2)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{I}_{\text {EE }}$ | Negative Power Supply Current | 35 | 45 | 55 | 35 | 45 | 55 | 35 | 48 | 58 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 3) | 1355 | 1480 | 1605 | 1355 | 1480 | 1605 | 1355 | 1480 | 1605 | mV |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage (Note 3) | 555 | 775 | 900 | 555 | 775 | 900 | 555 | 775 | 900 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (SELO, SEL1, COM_SEL) Input HIGH Voltage (D Inputs) (Note 4) | $\begin{aligned} & 1335 \\ & 1335 \end{aligned}$ |  | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{CC}} \\ & 1620 \end{aligned}$ | $\begin{aligned} & 1335 \\ & 1335 \end{aligned}$ |  | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{cc}} \\ & 1620 \end{aligned}$ | $\begin{aligned} & 1275 \\ & 1275 \end{aligned}$ |  | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{CC}} \\ & 1620 \end{aligned}$ | mV |
| $\mathrm{V}_{\mathrm{IL}}$ | Input LOW Voltage (SELO, SEL1, COM_SEL) Input LOW Voltage (D Inputs) (Note 4) | $\begin{aligned} & \mathrm{V}_{\mathrm{EE}} \\ & 555 \end{aligned}$ |  | $\begin{aligned} & 875 \\ & 875 \end{aligned}$ | $\begin{aligned} & V_{\text {EE }} \\ & 555 \end{aligned}$ |  | $\begin{aligned} & 875 \\ & 875 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{EE}} \\ & 555 \end{aligned}$ |  | $\begin{aligned} & 875 \\ & 875 \end{aligned}$ | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 5) | 1.2 |  | 2.5 | 1.2 |  | 2.5 | 1.2 |  | 2.5 | V |
| $\mathrm{IIH}^{\text {H }}$ | Input HIGH Current (@V1H) |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| IIL | Input LOW Current (@VIL)D <br>  <br>  <br> SEL | $\begin{array}{\|c\|} \hline 0.5 \\ -150 \\ -150 \end{array}$ |  |  | $\begin{gathered} \hline 0.5 \\ -150 \\ -150 \end{gathered}$ |  |  | $\begin{gathered} \hline 0.5 \\ -150 \\ -150 \end{gathered}$ |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm.
2. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. $\mathrm{V}_{\mathrm{EE}}$ can vary -0.125 V to +1.3 V .
3. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$.
4. Do not use $\mathrm{V}_{\mathrm{BB}}$ at $\mathrm{V}_{\mathrm{CC}}<3.0 \mathrm{~V}$.
5. $\mathrm{V}_{\mathrm{IHCMR}}$ min varies $1: 1$ with $\mathrm{V}_{\mathrm{EE}}, \mathrm{V}_{\mathrm{IHCMR}}$ max varies $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. The $\mathrm{V}_{\mathrm{IHCMR}}$ range is referenced to the most positive side of the differential input signal.

Table 6. DC CHARACTERISTICS, PECL $V_{C C}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}$ (Note 6)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{I}_{\text {EE }}$ | Negative Power Supply Current | 35 | 45 | 55 | 35 | 45 | 55 | 35 | 48 | 58 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 7) | 2155 | 2280 | 2405 | 2155 | 2280 | 2405 | 2155 | 2280 | 2405 | mV |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage (Note 7) | 1355 | 1575 | 1700 | 1355 | 1575 | 1700 | 1355 | 1575 | 1700 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (SELO, SEL1, COM_SEL) Input HIGH Voltage (D Inputs) | $\begin{array}{\|l\|} \hline 2135 \\ 2135 \end{array}$ |  | $\begin{array}{\|l\|} \hline \mathrm{V}_{\mathrm{CC}} \\ 2420 \end{array}$ | $\begin{array}{\|l\|} \hline 2135 \\ 2135 \end{array}$ |  | $\begin{array}{\|l\|} \hline \mathrm{V}_{\mathrm{CC}} \\ 2420 \end{array}$ | $\begin{aligned} & 2135 \\ & 2135 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}} \\ & 2420 \end{aligned}$ | mV |
| $\mathrm{V}_{\mathrm{IL}}$ | Input LOW Voltage (SELO, SEL1, COM_SEL) Input LOW Voltage (D Inputs) | $\begin{aligned} & \mathrm{V}_{\mathrm{EEE}} \\ & 1355 \end{aligned}$ |  | $\begin{aligned} & 1675 \\ & 1675 \end{aligned}$ | $\begin{array}{\|c} \hline \mathrm{V}_{\mathrm{EE}} \\ 1355 \end{array}$ |  | $\begin{array}{l\|} \hline 1675 \\ 1675 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{EE}} \\ & 1355 \end{aligned}$ |  | $\begin{aligned} & 1675 \\ & 1675 \end{aligned}$ | mV |
| $\mathrm{V}_{\mathrm{BB}}$ | Output Reference Voltage (Note 8) | 1775 | 1875 | 1975 | 1775 | 1875 | 1975 | 1775 | 1875 | 1975 | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 9) | 1.2 |  | 3.3 | 1.2 |  | 3.3 | 1.2 |  | 3.3 | V |
| IIH | Input HIGH Current (@V1H) |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| IIL | Input LOW Current (@VIL)$\frac{D}{D}$ <br>  <br>  <br>  | $\begin{array}{\|c\|} \hline 0.5 \\ -150 \\ -150 \end{array}$ |  |  | $\begin{array}{\|c\|} \hline 0.5 \\ -150 \\ -150 \end{array}$ |  |  | $\begin{gathered} \hline 0.5 \\ -150 \\ -150 \end{gathered}$ |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm.
6. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}} . \mathrm{V}_{\mathrm{EE}}$ can vary +0.5 V to -0.3 V .
7. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$.
8. Single-Ended input operation is limited to $\mathrm{V}_{\mathrm{CC}} \geq 3.0 \mathrm{~V}$ in PECL mode.
9. $\mathrm{V}_{\text {IHCMR }}$ min varies $1: 1$ with $\mathrm{V}_{\text {EE }}, \mathrm{V}_{\text {IHCMR }}$ max varies $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. The $\mathrm{V}_{\text {IHCMR }}$ range is referenced to the most positive side of the differential input signal.

Table 7. DC CHARACTERISTICS, NECL $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-3.8 \mathrm{~V}$ to -2.375 V (Note 10)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| IEE | Negative Power Supply Current | 35 | 45 | 55 | 35 | 45 | 55 | 35 | 48 | 58 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 11) | -1145 | -1020 | -895 | -1145 | -1020 | -895 | -1145 | -1020 | -895 | mV |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage (Note 11) | -1945 | -1725 | -1600 | -1945 | -1725 | -1600 | -1945 | -1725 | -1600 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (SELO, SEL1, COM_SEL) Input HIGH Voltage (D Inputs) | $\begin{aligned} & -1165 \\ & -1165 \end{aligned}$ |  | $\begin{aligned} & V_{C C} \\ & -880 \end{aligned}$ | $\begin{aligned} & -1165 \\ & -1165 \end{aligned}$ |  | $\begin{aligned} & V_{C C} \\ & -880 \end{aligned}$ | $\begin{aligned} & -1165 \\ & -1165 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}} \\ & -880 \end{aligned}$ | mV |
| VIL | Input LOW Voltage (SELO, SEL1, COM SEL) Input LOW Voltage (D Inputs) | $\begin{aligned} & V_{\text {EEE }} \\ & -1945 \end{aligned}$ |  | $\begin{aligned} & -1600 \\ & -1600 \end{aligned}$ | $\begin{gathered} \mathrm{V}_{\mathrm{EEE}} \\ -1945 \end{gathered}$ |  | $\begin{aligned} & -1600 \\ & -1600 \end{aligned}$ | $\begin{gathered} V_{\mathrm{EEE}} \\ -1945 \end{gathered}$ |  | $\begin{aligned} & -1600 \\ & -1600 \end{aligned}$ | mV |
| $\mathrm{V}_{\mathrm{BB}}$ | Output Reference Voltage (Note 12) | -1525 | -1425 | -1325 | -1525 | -1425 | -1325 | -1525 | -1425 | -1325 | mV |
| VIHCMR | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 13) | $\mathrm{V}_{\mathrm{EE}}$ | +1.2 | 0.0 | $\mathrm{V}_{\text {EE }}$ | +1.2 | 0.0 | $\mathrm{V}_{\mathrm{EE}}$ |  | 0.0 | V |
| $\mathrm{IIH}^{\text {H }}$ | Input HIGH Current (@V1/ ${ }_{\text {I }}$ ) |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| ILL | Input LOW Current (@VIL)D <br>  <br>  <br> SEL | $\begin{gathered} \hline 0.5 \\ -150 \\ -150 \end{gathered}$ |  |  | $\begin{gathered} \hline 0.5 \\ -150 \\ -150 \end{gathered}$ |  |  | $\begin{gathered} \hline 0.5 \\ -150 \\ -150 \end{gathered}$ |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm.
10. Input and output parameters vary $1: 1$ with $V_{\mathrm{CC}}$.
11. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$.
12. Single-Ended input operation is limited to $\mathrm{V}_{\mathrm{EE}}$ from -3.0 V to -5.5 V in NECL mode.
13. $\mathrm{V}_{\text {IHCMR }}$ min varies $1: 1$ with $\mathrm{V}_{\text {EE }}, \mathrm{V}_{\text {IHCMR }}$ max varies $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. The $\mathrm{V}_{\text {IHCMR }}$ range is referenced to the most positive side of the differential input signal.

Table 8. AC CHARACTERISTICS $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$; $\mathrm{V}_{\mathrm{EE}}=-2.375 \mathrm{~V}$ to -3.8 V or $\mathrm{V}_{\mathrm{CC}}=2.375 \mathrm{~V}$ to 3.8 V ; $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$ (Note 14)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| V ${ }_{\text {OUTPP }}$ | Output Voltage Amplitude $f_{\text {in }} \leq 1 \mathrm{GHz}$ <br> (See Figure 3) $f_{\text {in }}=2 \mathrm{GHz}$ <br>  $\mathrm{fin}_{\text {in }}=2.5 \mathrm{GHz}$ | $\begin{aligned} & 525 \\ & 500 \\ & 400 \end{aligned}$ | $\begin{aligned} & \hline 700 \\ & 600 \\ & 500 \end{aligned}$ |  | $\begin{aligned} & 550 \\ & 500 \\ & 350 \end{aligned}$ | $\begin{aligned} & \hline 700 \\ & 600 \\ & 450 \end{aligned}$ |  | $\begin{aligned} & 500 \\ & 400 \\ & 200 \end{aligned}$ | $\begin{aligned} & 700 \\ & 500 \\ & 300 \end{aligned}$ |  | mV |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}}, \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Propagation Delay to Output Differential S to $Q, \bar{Q}$ SEL to $Q, \frac{Q}{Q}$ COM_SEL to $Q, Q$ | $\begin{aligned} & 375 \\ & 575 \\ & 550 \end{aligned}$ | $\begin{aligned} & 500 \\ & 775 \\ & 750 \end{aligned}$ | $\begin{aligned} & 625 \\ & 975 \\ & 950 \end{aligned}$ | $\begin{aligned} & 400 \\ & 625 \\ & 600 \end{aligned}$ | $\begin{aligned} & 525 \\ & 825 \\ & 800 \end{aligned}$ | $\begin{aligned} & 650 \\ & 1025 \\ & 1000 \end{aligned}$ | $\begin{aligned} & 450 \\ & 700 \\ & 700 \end{aligned}$ | $\begin{aligned} & 575 \\ & 900 \\ & 900 \end{aligned}$ | $\begin{gathered} 700 \\ 1100 \\ 1100 \end{gathered}$ | ps |
| ${ }_{\text {tskew }}$ | Pulse Skew (Note 15) <br> Within Device Input Skew (Note 16) Within Device Output Skew (Note 17) Device-to-Device Skew (Note 18) |  | $\begin{gathered} 10 \\ 5 \\ 15 \\ 50 \end{gathered}$ | $\begin{gathered} \hline 50 \\ 30 \\ 50 \\ 200 \end{gathered}$ |  | 10 5 15 50 |  |  | 10 5 15 50 | $\begin{gathered} \hline 50 \\ 30 \\ 50 \\ 200 \end{gathered}$ | ps |
| $\mathrm{t}_{\text {IITTER }}$ | RMS Random Clock Jitter (Note 19) <br> $@ \leq 1.0 \mathrm{GHz}$ <br> @ $\leq 1.5 \mathrm{GHz}$ <br> @ $\leq 2.0 \mathrm{GHz}$ <br> @ $\leq 2.5 \mathrm{GHz}$ <br> Peak-to-Peak Data Dependent Jitter (Note 20) <br> @ 0.5 GHz <br> @ 1.25 GHz <br> @ 2.488 GHz |  | $\begin{gathered} 0.269 \\ 0.306 \\ 0.250 \\ 0.339 \\ 4.1 \\ 32.2 \\ 30.8 \end{gathered}$ | $\begin{aligned} & 0.4 \\ & 0.4 \\ & 0.4 \\ & 0.8 \\ & 16 \\ & 80 \\ & 66 \end{aligned}$ |  | $\begin{gathered} 0.307 \\ 0.303 \\ 0.305 \\ 0.895 \\ \\ 4.6 \\ 22.6 \\ 27.2 \end{gathered}$ | $\begin{aligned} & 0.4 \\ & 0.4 \\ & 0.5 \\ & 2.0 \\ & \\ & 15 \\ & 63 \\ & 56 \end{aligned}$ |  | $\begin{gathered} 0.371 \\ 0.391 \\ 0.722 \\ 2.443 \\ \\ 4.4 \\ 22 \\ 24.4 \end{gathered}$ | $\begin{aligned} & 0.5 \\ & 0.6 \\ & 1.2 \\ & 7.7 \\ & 16 \\ & 53 \\ & 54 \end{aligned}$ | ps |
| $\mathrm{V}_{\text {INPP }}$ | Input Voltage Swing (Differential Configuration) (Note 21) | 150 | 800 | 1200 | 150 | 800 | 1200 | 150 | 800 | 1200 | mV |
| $\begin{aligned} & \mathrm{t}_{\mathrm{r}} \\ & \mathrm{t}_{\mathrm{f}} \end{aligned}$ | Output Rise/Fall Times @ 50 MHz Q,Q <br> $(20 \%-80 \%)$ | 60 | 110 | 150 | 60 | 120 | 170 | 90 | 140 | 230 | ps |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.
14. Measured using a 750 mV source, $50 \%$ duty cycle clock source. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$. Input edge rates $150 \mathrm{ps}(20 \%-80 \%)$. 15. Pulse Skew |tpLH - tpHL|
16. Worst case difference between D0a and DOb (or between D1a or D1b), when both output come from same input.
17. Worst case difference between Q0 and Q1 outputs.
18. Skew is measured between outputs under identical transitions.
19. Additive RMS jitter with $50 \%$ Duty Cycle Clock Signal.
20. Additive Peak-to-Peak jitter with input NRZ data at PRBS $2^{31}-1$.
21. Input voltage swing is a single-ended measurement operating in differential mode.


Figure 3. Output Voltage Amplitude ( $\mathrm{V}_{\text {OUTPP }}$ ) vs.
Input Frequency ( $\mathrm{f}_{\mathrm{in}}$ ) at $\mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V}, 25^{\circ} \mathrm{C}$


Figure 4. AC Reference Measurement


Figure 5. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D - Termination of ECL Logic Devices.)
Resource Reference of Application Notes
AN1405/D - ECL Clock Distribution Techniques
AN1406/D - Designing with PECL (ECL at +5.0 V)
AN1503/D - ECLinPS ${ }^{m m}$ I/O SPiCE Modeling Kit
AN1504/D - Metastability and the ECLinPS Family
AN1568/D - Interfacing Between LVDS and ECL
AN1672/D - The ECL Translator Guide
AND8001/D - Odd Number Counters Design
AND8002/D - Marking and Date Codes
AND8020/D - Termination of ECL Logic Devices
AND8066/D - Interfacing with ECLinPS
AND8090/D - AC Characteristics of ECL Devices

QFN24, 4x4, 0.5P
CASE 485L
ISSUE B
DATE 05 JUN 2012
SCALE 2:1


DETAIL A
alternate CONSTRUCTIONS


DETAIL B ALTERNATE TERMINAL CONSTRUCTIONS
notes:

1. Dimensioning and tolerancing per asme Y14.5M, 1994
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION $\operatorname{b}$ APPLES TO PLATED TERMINAL

AND IS MEASURED BETWEEN 0.25 AND 0.30 Mn FROM THE TERMINALTIP.
4. COPLANARITY APPLES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS |  |
| :---: | :---: | :---: |
|  | MIN | MAX |
| A | 0.80 | 1.00 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 REF |  |
| b | 0.20 |  |
| D | 0.30 |  |
| D2 | 2.70 |  |
| E | 2.90 |  |
| E2 | 4.00 |  |
|  |  | BSC |
| e | 0.50 |  |
| L | 0.30 | 2.90 |
| L1 | 0.05 | 0.50 |

## GENERIC <br> MARKING DIAGRAM*

| ${ }^{0}$ XXXXX |
| :---: |
| XXXXX |
| ALYW. |

- 

XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

- $\quad=$ Pb-Free Package
(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, " $G$ " or microdot " $\mathrm{\bullet}$ ", may or may not be present.

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